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## **ON Semiconductor**®

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#### April 2015

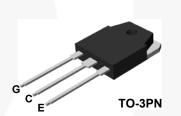
- Maximum Junction Temperature : T<sub>J</sub> = 175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- · High Current Capability
- Low Saturation Voltage: V<sub>CE(sat)</sub> = 1.45 V (Typ.) @ I<sub>C</sub> = 40 A
- 100% of the Parts tested for I<sub>LM</sub>(1)
- · High Input Impedance
- · Fast Switching
- · Tighten Parameter Distribution
- RoHS Compliant

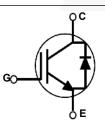
### **General Description**

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer superior conduction and switching performance and easy parallel operation. This device is well suited for the resonant or soft switching application such as induction heating and MWO.

#### Applications

Induction Heating, MWO





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		FGA40T65SHDF	Unit	
V <sub>CES</sub>	Collector to Emitter Voltage		650	V	
V <sub>GES</sub>	Gate to Emitter Voltage	± 20	V		
	Transient Gate to Emitter Voltage		± 30	V	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	80	A	
	Collector Current	@ T <sub>C</sub> = 100°C	40	A	
I <sub>LM</sub> (1)	Pulsed Collector Current $@ T_C = 25^{\circ}C$		120	A	
I <sub>CM</sub> (2)	Pulsed Collector Current		120	A	
I <sub>F</sub>	Diode Forward Current	@ T <sub>C</sub> = 25°C	40	A	
'F	Diode Forward Current	@ T <sub>C</sub> = 100°C	20	A	
I <sub>FM</sub>	Pulsed Diode Maximum Forward Cur	rent	60	A	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	268	W	
· D	Maximum Power Dissipation $@T_{C} = 100^{\circ}C$		134	W	
TJ	Operating Junction Temperature		-55 to +175	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C	
Τ <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1. V<sub>CC</sub> = 400 V, V<sub>GE</sub> = 15 V, I<sub>C</sub> = 120 A, R<sub>G</sub> = 30  $\Omega$ , Inductive Load 2. Repetitive rating: Pulse width limited by max. junction temperature

### Thermal Characteristics

Symbol	Parameter	FGA40T65SHDF	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.56	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.75	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

### Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGA40T65SHDF	FGA40T65SHDF	TO-3PN	Tube	-	-	30

### Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1 mA	650	-	-	V
$\Delta BV_{CES}^{}/$ $\Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1 mA	-	0.6	-	V/ºC
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	± 400	nA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	I <sub>C</sub> = 40 mA, V <sub>CE</sub> = V <sub>GE</sub>	4.0	5.5	7.5	V
. ,		I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	-	1.45	1.81	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$	-	1.8	-	V
Dynamic C	haracteristics					
C <sub>ies</sub>	Input Capacitance		-	1982	-	pF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 30 V <sub>,</sub> V <sub>GE</sub> = 0 V, f = 1 MHz	-	70	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance		-	25	-	pF
Switching	Characteristics					
T <sub>d(on)</sub>	Turn-On Delay Time		-	18	- /	ns
T <sub>r</sub>	Rise Time		-	27	-	ns
T <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 40 A,	-	64	-	ns
T <sub>f</sub>	Fall Time	R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,	-	3		ns
Eon	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 25°C	-	1.22		mJ
E <sub>off</sub>	Turn-Off Switching Loss		-	0.44	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	1.66	-	mJ
T <sub>d(on)</sub>	Turn-On Delay Time		-	18	-	ns
T <sub>r</sub>	Rise Time		-	31	-	ns
T <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 40 A,	-	70	-	ns
T <sub>f</sub>	Fall Time	$R_G = 6 \Omega$ , $V_{GE} = 15 V$ ,	-	56	-	ns
E <sub>on</sub>	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 175°C	-	1.78	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss		-	0.78	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	2.56	-	mJ

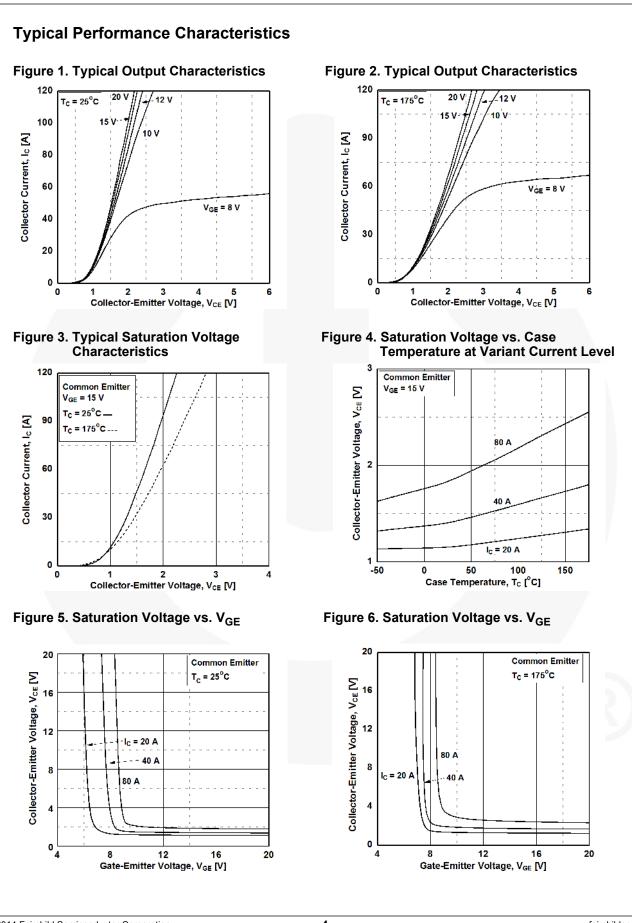
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### Electrical Characteristics of the IGBT (Continued)

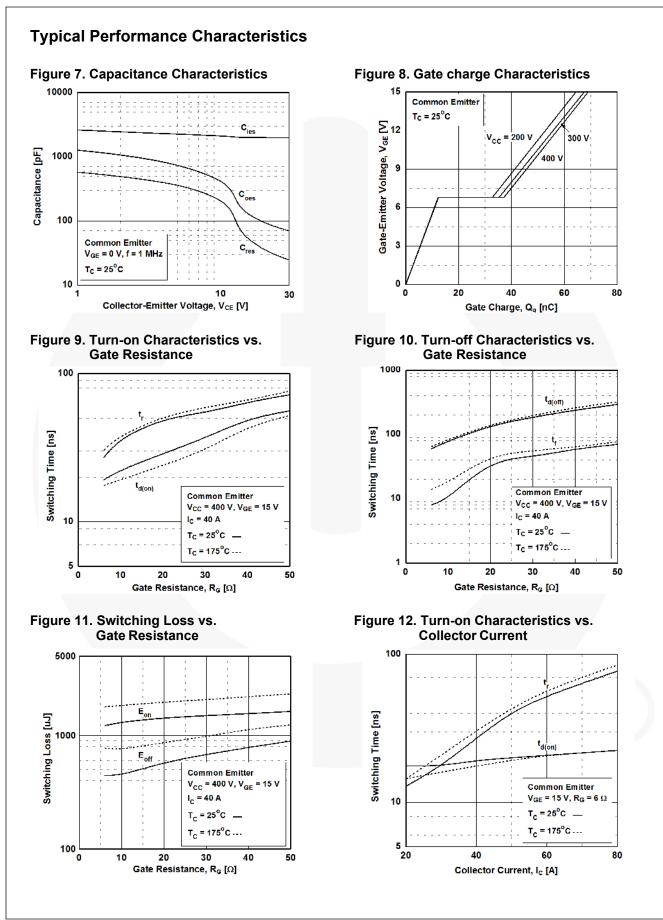
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	-	68	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge		-	12	-	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	25	-	nC

### Electrical Characteristics of the Diode T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions		Min.	Тур.	Max.	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> =	20 A	T <sub>C</sub> = 25°C	-	1.5	1.95	V
				T <sub>C</sub> = 175°C	-	1.37	-	
E <sub>rec</sub>	Reverse Recovery Energy			T <sub>C</sub> = 175 <sup>o</sup> C	-	153	-	μJ
T <sub>rr</sub> Diode Reverse Recover	Diode Reverse Recovery Time	I <sub>F</sub> = 20 A, dI <sub>F</sub> /dt = 200 A/µ	$20 A dl_{-}/dt = 200 A/us$	T <sub>C</sub> = 25°C	-	101	-	ns
		'F -	20 A, dip/dt - 200 A/µ3	T <sub>C</sub> = 175°C		238	-	
Q <sub>rr</sub>	Diode Reverse Recovery Charge			T <sub>C</sub> = 25 <sup>o</sup> C	-	343	-	nC
				T <sub>C</sub> = 175 <sup>o</sup> C	-	1493	-	

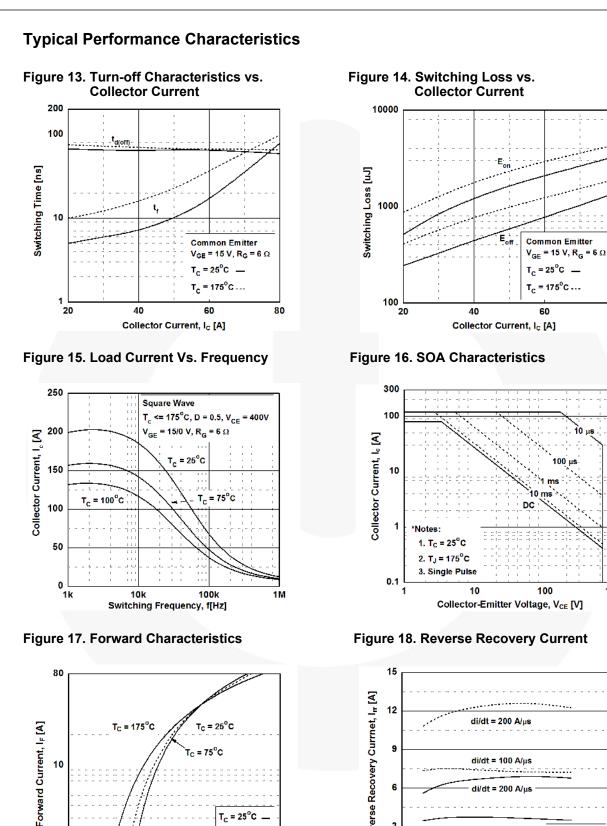


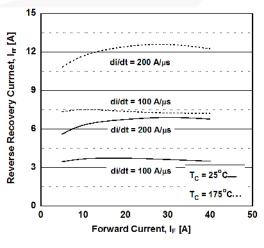
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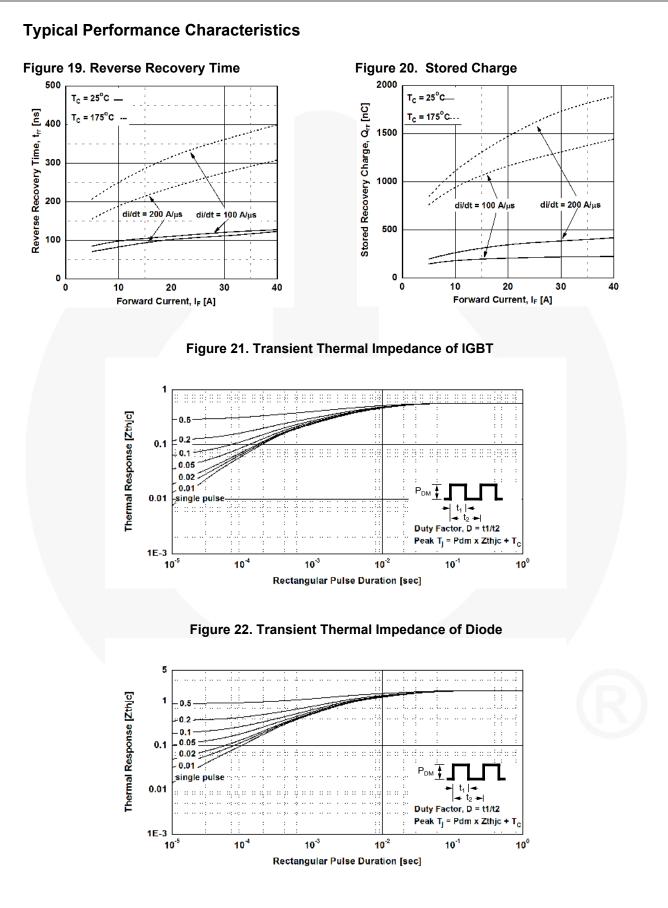
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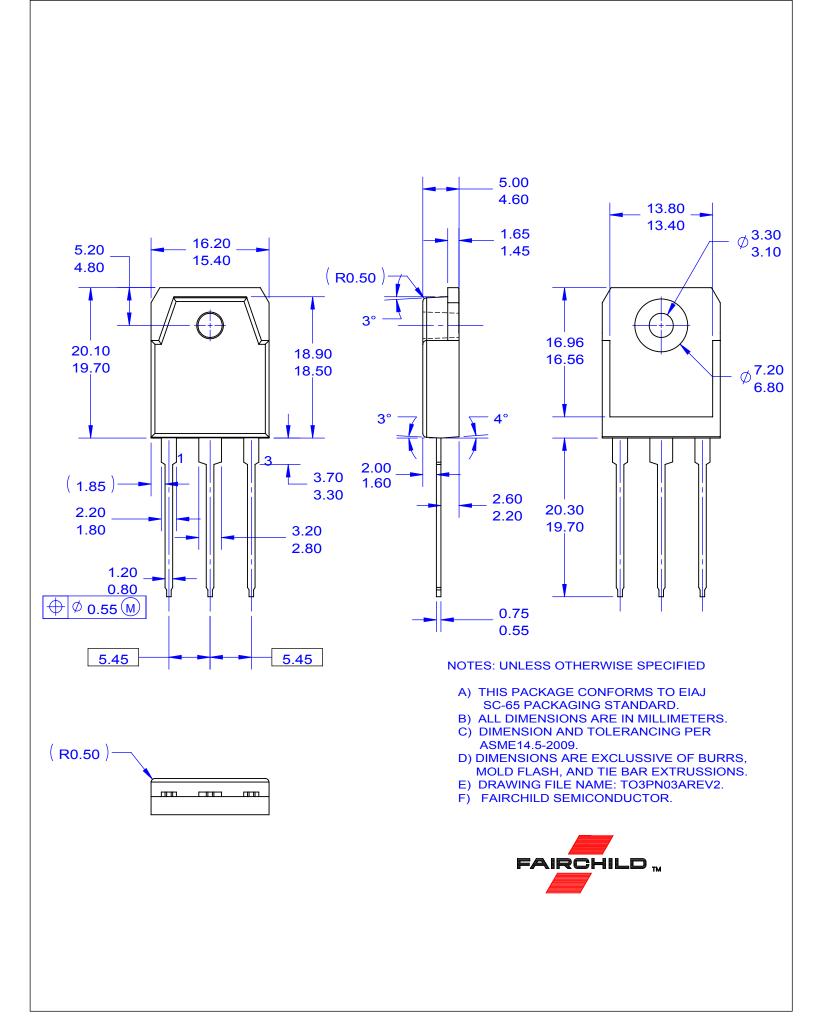
T<sub>c</sub> = 25°C \_

T<sub>C</sub> = 75°C T<sub>c</sub> = 175°C

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